

N-Channel 30-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | | |
|---------------------|----------------------------------|---------------------------------|-----------------------|--|--|--|--|
| V _{DS} (V) | $R_{DS(on)}\left(\Omega\right)$ | I _D (A) ^a | Q _g (Typ.) | | | | |
| 30 | 0.022 at V _{GS} = 4.5 V | 6.8 | 10 nC | | | | |
| 30 | 0.027 at V _{GS} = 2.5 V | 6.0 | 10110 | | | | |

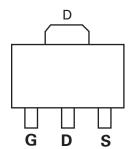
FEATURES

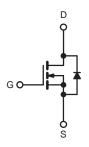
- · Halogen-free
- TrenchFET® Power MOSFET



APPLICATIONS

· Load Switches for Portable Devices





N-Channel MOSFET

| Parameter | Symbol | Limit | Unit | | |
|---|-----------------------------------|----------------|------------------------|----|--|
| Drain-Source Voltage | V _{DS} | 30 | V | | |
| Gate-Source Voltage | V _{GS} | ± 20 | | | |
| | T _C = 25 °C | | 6.8 ^a | | |
| Continuous Drain Current (T _{.1} = 150 °C) | T _C = 70 °C | 1 . | 6 ^a | | |
| Continuous Dialit Current (1) = 130 °C) | T _A = 25 °C | l _D | 6.8 ^{a, b, c} | | |
| | T _A = 70 °C | | 6 ^{a, b, c} | A | |
| Pulsed Drain Current | I _{DM} | 30 | | | |
| Continuous Source-Drain Diode Current | T _C = 25 °C | I _S | 5.2 | | |
| Continuous Source-Diain Diode Current | T _A = 25 °C | 'S | 2.1 ^{b, c} | | |
| | T _C = 25 °C | | 6.3 | | |
| Maximum Power Dissipation | T _C = 70 °C | P _D | 4 | W | |
| Maximum Fower Dissipation | T _A = 25 °C | 1 'D | 2.5 ^{b, c} | VV | |
| | T _A = 70 °C | | 1.6 ^{b, c} | | |
| Operating Junction and Storage Temperatur | T _J , T _{stg} | - 55 to 150 | °C | | |
| Soldering Recommendations (Peak Temperature | ature) ^{e, f} | | 260 | | |

| THERMAL RESISTANCE RATINGS | | | | | | | | |
|--|--------------|-------------------|---------|------|------|--|--|--|
| Parameter | Symbol | Typical | Maximum | Unit | | | | |
| Maximum Junction-to-Ambient ^{a, c, d} | t ≤ 5 s | R _{thJA} | 40 | 50 | °C/W | | | |
| Maximum Junction-to-Foot (Drain) | Steady State | R_{thJF} | 15 | 20 |] | | | |

- a. Package limited, T_C = 25 °C.
 b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 95 °C/W.
- e. See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- f. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.



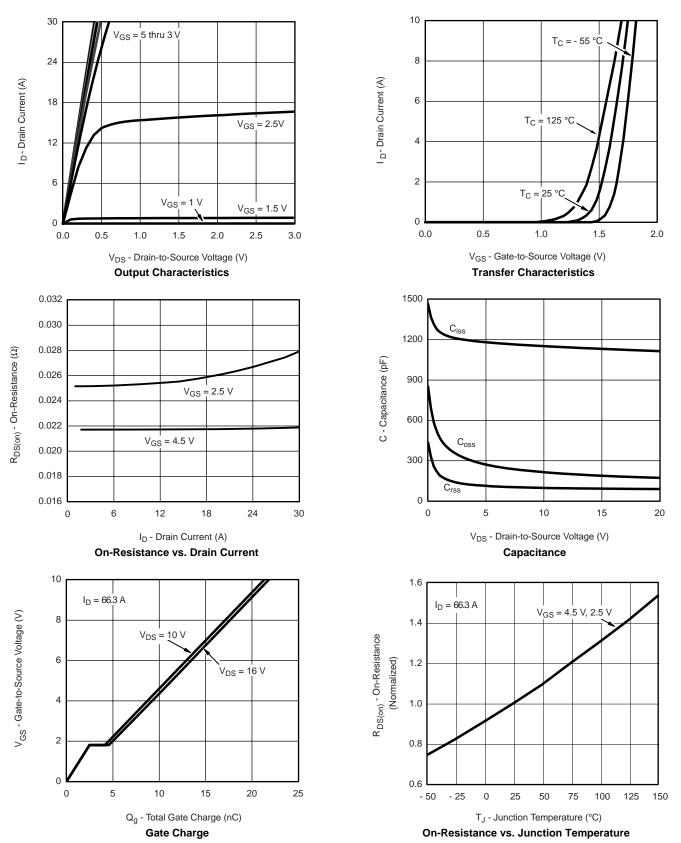
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit |
|---|-------------------------|---|------|-------|-------|-------|
| Static | • | | | | | |
| Drain-Source Breakdown Voltage | V_{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 30 | | | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | I _D = 250 μA | | 25 | | |
| V _{GS(th)} Temperature Coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | | - 4.0 | | mV/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$ | 0.6 | | 1.5 | V |
| Gate-Source Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA |
| Zana Oata Waltana Busin Oamani | 1 | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | μΑ |
| Zero Gate Voltage Drain Current | IDSS | $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$ | | | 10 | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ | 30 | | | Α |
| | ` ' | $V_{GS} = 4.5 \text{ V}, I_D = 6.3 \text{ A}$ | | 0.022 | 0.033 | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = 2.5 \text{ V}, I_D = 4.5 \text{ A}$ | | 0.030 | 0.045 | Ω |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 10 V, I _D = 6.3 A | | 45 | | S |
| Dynamic ^b | -10 | 20 2 | | | | l |
| Input Capacitance | C _{iss} | | | 1200 | | |
| Output Capacitance | C _{oss} | $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | | 220 | | pF |
| Reverse Transfer Capacitance | C _{rss} | | | 100 | | |
| | Qg | $V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 6.3 \text{ A}$ | | 22 | 33 | nC |
| Total Gate Charge | | 20 00 2 | | 10 | 15 | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 6.3 \text{ A}$ | | 2.5 | | |
| Gate-Drain Charge | Q _{gd} | | | 1.7 | | |
| Gate Resistance | R_g | f = 1 MHz | | 2.4 | | Ω |
| Turn-on Delay Time | t _{d(on)} | | | 15 | 25 | |
| Rise Time | t _r | $V_{DD} = 10 \text{ V}, R_1 = 1.5 \Omega$ | | 10 | 15 | ns |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 6.7 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$ | | 35 | 55 | |
| Fall Time | t _f | | | 12 | 20 | |
| Turn-on Delay Time | t _{d(on)} | | | 10 | 15 | |
| Rise Time | t _r | $V_{DD} = 10 \text{ V}, R_{L} = 1.5 \Omega$ | | 12 | 20 | |
| Turn-Off Delay Time | t _{d(off)} | $I_D \cong 6.7 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$ | | 25 | 40 | |
| Fall Time | t _f | · | | 10 | 15 | = |
| Drain-Source Body Diode Characteristi | cs | | | | | l |
| Continuous Source-Drain Diode Current | I _S | T _C = 25 °C | | | 5.2 | |
| Pulse Diode Forward Current | I _{SM} | | | | 30 | A |
| Body Diode Voltage | V _{SD} | $I_S = 6.7 \text{ A}, V_{GS} = 0 \text{ V}$ | | 0.8 | 1.2 | V |
| Body Diode Reverse Recovery Time | t _{rr} | | | 20 | 40 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | L 67 A dl/dt 400 A/ T 05 00 | | 10 | 20 | nC |
| Reverse Recovery Fall Time | t _a | $I_F = 6.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ | | 10 | | |
| Reverse Recovery Rise Time | | t _b | | 10 | | ns |

Notes:

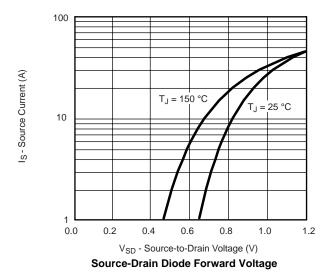
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing.

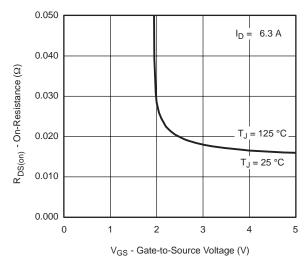
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



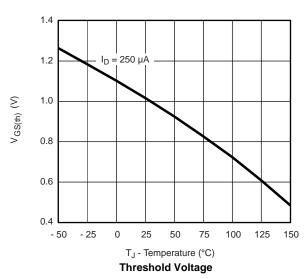


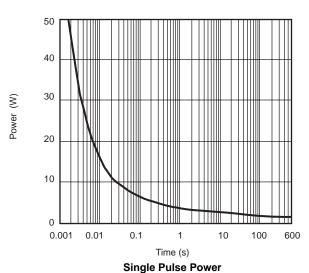






On-Resistance vs. Gate-to-Source Voltage





Limited by $R_{DS(on)}^*$ 10

Limited by $R_{DS(on)}^*$ 10 us

10 ms

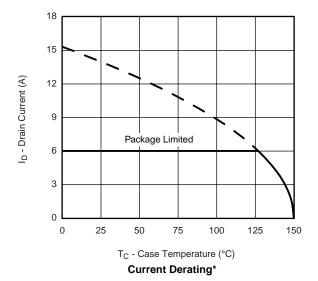
100 ms

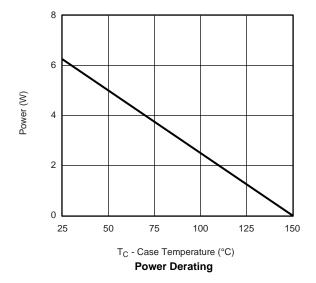
10 s

10

Safe Operating Area, Junction-to-Ambient

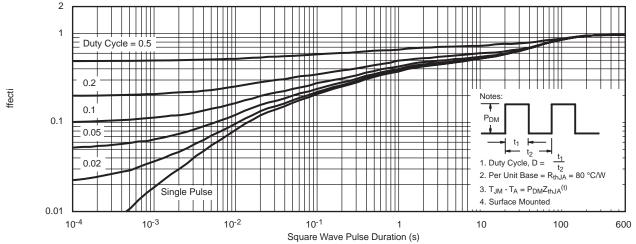




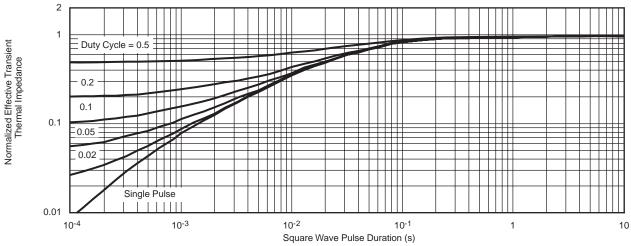


^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



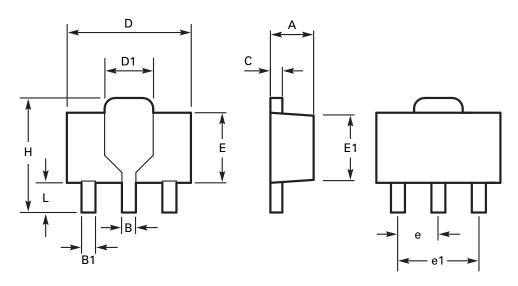
Normalized Thermal Transient Impedance, Junction-to-Foot

E-mail: China@VBsemi TEL:86-755-83251052

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Package outline - SOT89



| DIM | Millin | neters | Inc | hes | DIM | Millimeters | | OIM Millimeters Inches | | hes |
|-----|--------|--------|-------|-------|-----|-------------|------|------------------------|-------|-----|
| | Min | Max | Min | Max | | Min | Max | Min | Max | |
| Α | 1.40 | 1.60 | 0.550 | 0.630 | Е | 2.29 | 2.60 | 0.090 | 0.102 | |
| В | 0.44 | 0.56 | 0.017 | 0.022 | E1 | 2.13 | 2.29 | 0.084 | 0.090 | |
| B1 | 0.36 | 0.48 | 0.014 | 0.019 | е | 1.50 BSC | | 0.059 BSC | | |
| С | 0.35 | 0.44 | 0.014 | 0.017 | e1 | 3.00 BSC | | 0.118 BSC | | |
| D | 4.40 | 4.60 | 0.173 | 0.181 | Н | 3.94 | 4.25 | 0.155 | 0.167 | |
| D1 | 1.62 | 1.83 | 0.064 | 0.072 | L | 0.89 | 1.20 | 0.035 | 0.047 | |

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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